

**APPLICATION DATA SHEET**

Electronic Version v14

Stylesheet Version v14.0

**Title of  
Invention**

Electromagnetic wave shielding window, manufacturing apparatus  
having the same, transport system having the same, building  
construction having the same, and electromagnetic wave shielding  
method

Application Type: regular, utility

Attorney Docket Number: 36607

Correspondence address:

**Customer Number:**

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Continuing Data:

This is a Continuation of IB application number PCT/JP01/08459, filed 2001-09-27.

Priority Data:

Doc.No: 2000-098242; Country - JP; Date: 2000-03-31 us-priority-not-claimed

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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